Electronic Patent Application Fee Transmittal								
Application Number:	10672521							
Filing Date:	26	-Sep-2003						
Title of Invention:	Wiring material, semiconductor device provided with a wiring using the wiring material and method of manufacturing thereof							
First Named Inventor/Applicant Name:	Toru Takayama							
Filer:	Mark James Murphy/Elizabeth Ortiz							
Attorney Docket Number:	0553-0193.01							
Filed as Large Entity								
Utility Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Miscellaneous:					
Request for continued examination	1801	1	790	790	
	Tota	Total in USD (\$)			